



#### RE430-LF

- PCI-Board
- Epoxy fibre-glass FR4 1.50 mm
- Double-sided 35 µm Cu
- Plated through holes (PTH)
- Hot air leveling (HAL-leadfree)
- Surface with component print and soldering stop mask
- Hole spacing 2.54 x 2.54 mm
- Soldering pads 2.00 mm Ø
- Hole diameter 1.00 mm
- Direct plug contacts gold-plated 1.50 µm: 2 x 11-channel 2 x 49-channel
- Connecting possibilities for D-subminiature plugs 9-/25-/37-channel DIN 41652
- 3 potential strips
- Solder bath proof: 260 °C. > 50 Sec.
- Size 167.61 x 106.68 mm